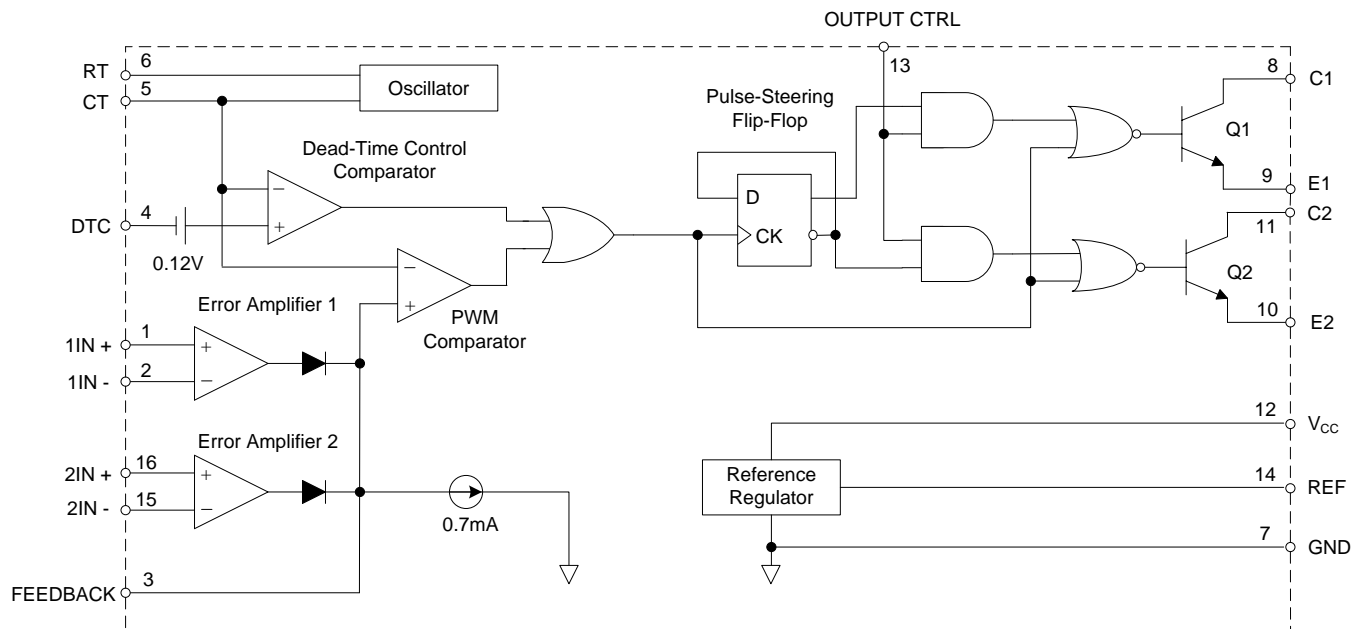


Output Function Table

Signal for Output Control	Output Function
$V_I = \text{GND}$	Single-ended or parallel output
$V_I = V_{\text{REF}}$	Normal push-pull operation

Functional Block Diagram



Absolute Maximum Ratings (Note 3)

Symbol	Parameter	Rating	Unit
V_{CC}	Supply Voltage (Note 4)	40	V
V_I	Amplifier Input Voltage	-0.3 to $V_{CC} + 0.3$	V
V_O	Collector Output Voltage	40	V
I_O	Collector Output Current	250	mA
$R_{\theta JA}$	Package Thermal Impedance (Note 5)	73	°C/W
—	Lead Temperature 1.6mm from case for 10 seconds	+260	°C
T_{STG}	Storage Temperature Range	-65 to +150	°C
—	ESD Rating (Machine Model)	200	V

Notes: 3. Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" is not implied. Exposure to "Absolute Maximum Ratings" for extended periods may affect device reliability.

4. All voltage values are with respect to the network ground terminal.

5. Maximum power dissipation is a function of $T_J(\text{max})$, $R_{\theta JA}$ and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(\text{max}) - T_A) / R_{\theta JA}$. Operating at the absolute maximum T_J of +150°C can affect reliability.

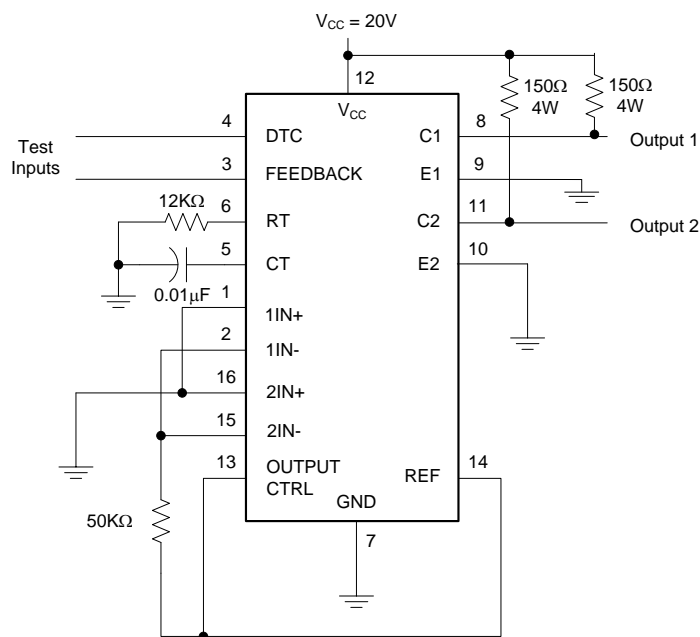
Recommended Operating Conditions

Symbol	Parameter	Min	Typ	Max	Unit
V_{CC}	Supply Voltage	7	15	36	V
V_{C1}, V_{C2}	Collector Output Voltage	—	30	36	V
I_{C1}, I_{C2}	Collector Output Current (Each Transistor)	—	—	200	mA
V_I	Amplifier Input Voltage	0.3	—	$V_{CC} - 2$	V
I_{FB}	Current Into Feedback Terminal	—	—	0.3	mA
I_{REF}	Reference Output Current	—	—	10	mA
C_T	Timing Capacitor	0.00047	0.001	10	μF
R_T	Timing Resistor	1.8	30	500	kΩ
f_{OSC}	Oscillator Frequency	1.0	40	200	kHz
—	PWM Input Voltage (Pin 3, 4, 14)	0.3	—	5.3	V
T_A	Operating Free-Air Temperature	-40	—	+85	°C

Electrical Characteristics (@V_{CC}=20V, T_A= +25°C, f=10kHz, unless otherwise specified.)

Symbol	Parameters		Conditions	Min	Typ	Max	Unit
Reference Section							
V _{REF}	Output Reference Voltage		I _{REF} =1mA	4.90	4.95	5.0	V
			I _{REF} =1mA, T _A = -40 to +85°C	4.85	4.95	5.05	V
R _{LINE}	Line Regulation		V _{CC} = 7V to 36V	–	2	25	mV
R _{LOAD}	Load Regulation		I _{REF} =1mA to 10mA	–	1	15	mV
I _{SC}	Short-Circuit Output Current		V _{REF} = 0V	10	35	50	mA
Oscillator Section							
f _{OSC}	Oscillator Frequency		C _T =0.001μF, R _T =30KΩ	–	40	–	kHz
			C _T =0.01μF, R _T =12KΩ	9.2	10	10.8	
			C _T =0.01μF, R _T =12KΩ, T _A = -40 to +85°C	9.0	–	12	
Δf /ΔT	Frequency Change with Temperature		C _T =0.01μF, R _T =12KΩ, T _A = -40 to +85°C	–	–	1	%
Dead-Time Control Section							
I _{BIAS}	Input Bias Current		V _{CC} =15V, V ₄ = 0 to 5.25V	–	-2	-10	μA
D(MAX)	Maximum Duty Cycle		V _{CC} =15V, V ₄ = 0V, Pin 13= V _{REF}	45	–	–	%
V _{ITH}	Input Threshold Voltage		Zero Duty Cycle	–	3	3.3	V
			Maximum Duty Cycle	0	–	–	
Error-Amplifier Section							
V _{IO}	Input Offset Voltage		V ₃ = 2.5V	–	2	10	mV
I _{IO}	Input Offset Current		V ₃ = 2.5V	–	25	250	nA
I _{BIAS}	Input Bias Current		V ₃ = 2.5V	–	0.2	1	μA
V _{CM}	Common-Mode Input Voltage Range		V _{CC} =7V to 36V	-0.3	–	V _{CC} -2	V
G _{VO}	Open-Loop Voltage Gain		V _O =0.5V to 3.5V	70	95	–	dB
BW	Unity-Gain Bandwidth		–	–	650	–	kHz
CMRR	Common-Mode Rejection Ratio		–	65	80	–	dB
I _{SINK}	Output Sink Current (Feedback)		V _{ID} = -15mV to -5V, V ₃ = 0.7V	-0.3	-0.7	–	mA
I _{SOURCE}	Output Source Current (Feedback)		V _{ID} =15mV to 5V, V ₃ = 3.5V	2	–	–	mA
PWM Comparator Section							
V _{ITH}	Input Threshold Voltage		Zero duty cycle	–	4	4.5	V
I _{SINK}	Input Sink Current		V ₃ = 0.7V	-0.3	-0.7	–	mA
Output Section							
V _{CE} (SAT)	Output Saturation Voltage	Common Emitter	V _E = 0V, I _C =200mA	–	1.1	1.3	V
V _{CC} (SAT)		Emitter Follower	V _{CC} = 15V, I _E = -200mA	–	1.5	2.5	
I _C (OFF)	Collector Off-State Current		V _{CE} = 36V, V _{CC} =36V	–	2	100	μA
I _E (OFF)	Emitter Off-State Current		V _{CC} = V _C = 36V, V _E = 0	–	–	-100	μA
Total Device							
I _{CC}	Supply Current		Pin 6 = V _{REF} , V _{CC} =15V	–	6	10	mA
Output Switching Characteristics							
t _R	Rise Time		Common Emitter Common Collector	–	100	200	ns
t _F	Fall Time		Common Emitter Common Collector	–	25	100	ns

Parameter Measurement Information



Test Circuit

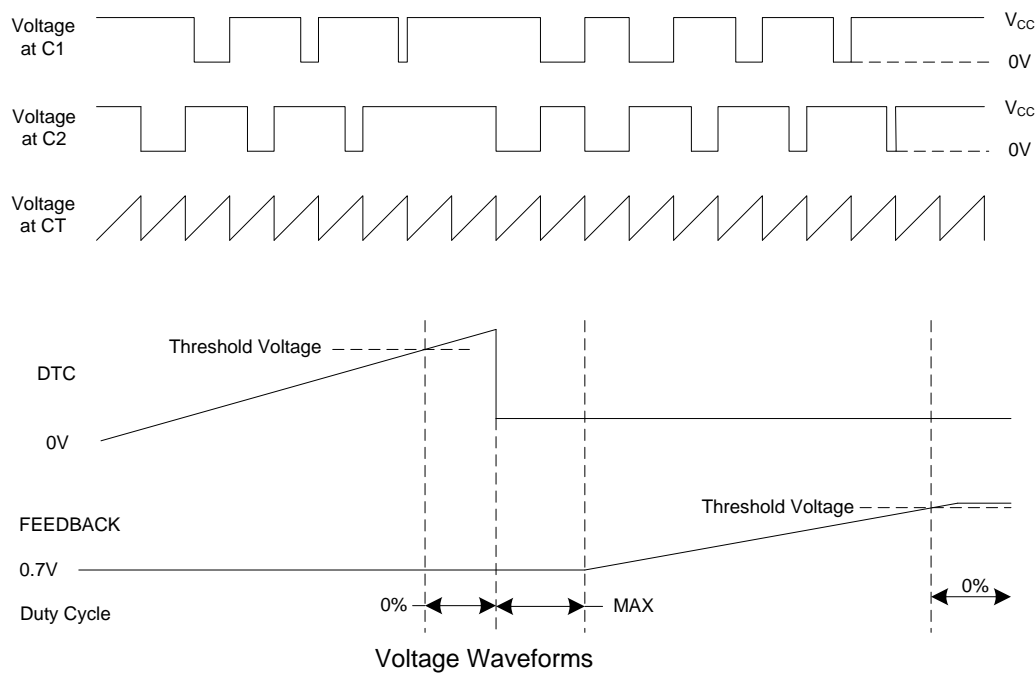


Figure 1. Operational Test Circuit and Waveforms

Parameter Measurement Information (Cont.)

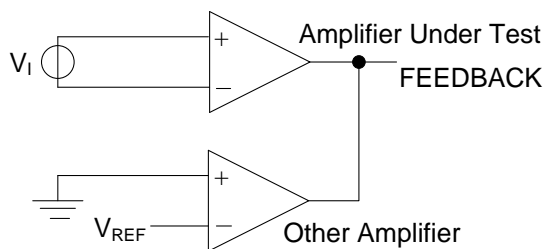
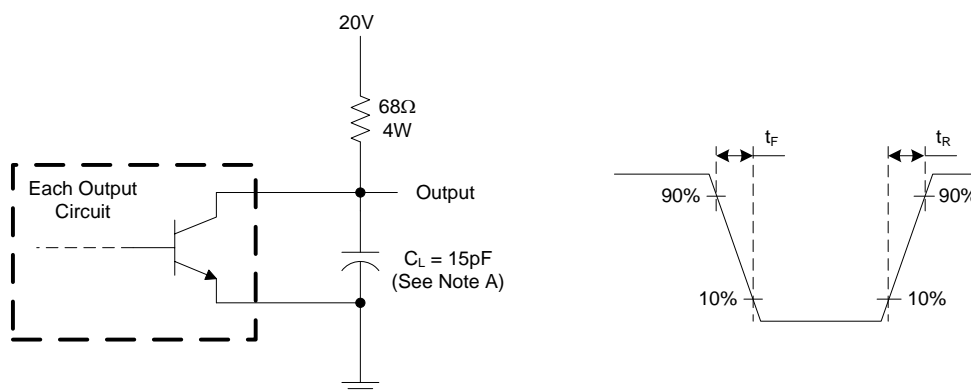
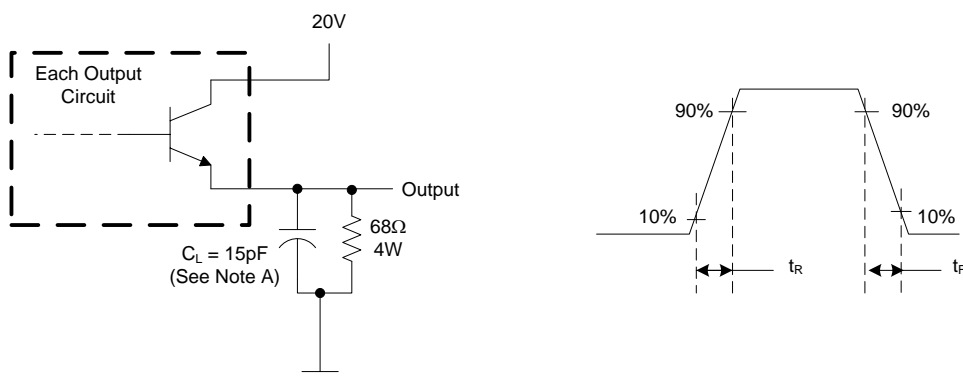


Figure 2. Error Amplifier Characteristics



Note A: C_L includes probe and jig capacitance.

Figure 3. Common-Emitter Configuration

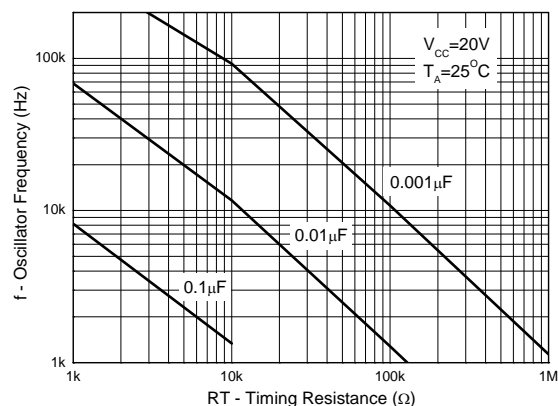


Note A: C_L includes probe and jig capacitance.

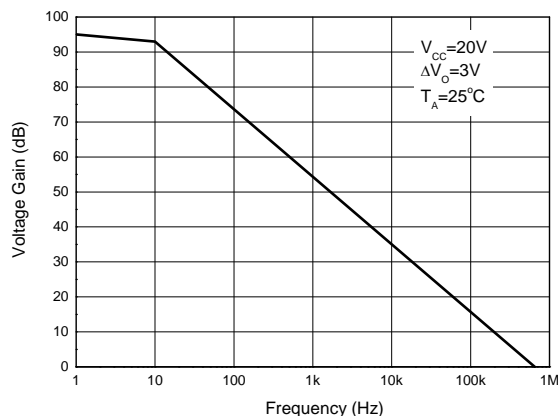
Figure 4. Emitter-Follower Configuration

Performance Characteristics

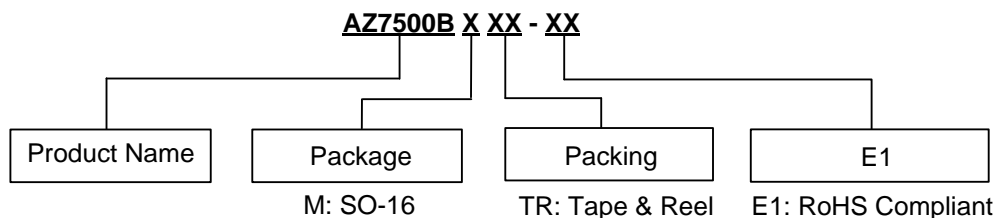
Oscillator Frequency vs. RT and CT



Error Amplifier Small-Signal Voltage Gain vs. Frequency



Ordering Information



Package	Temperature Range	Part Number	Marking ID	Packing
SO-16	-40 to +85°C	AZ7500BMTR-E1	AZ7500BM-E1	4000/Tape and Reel

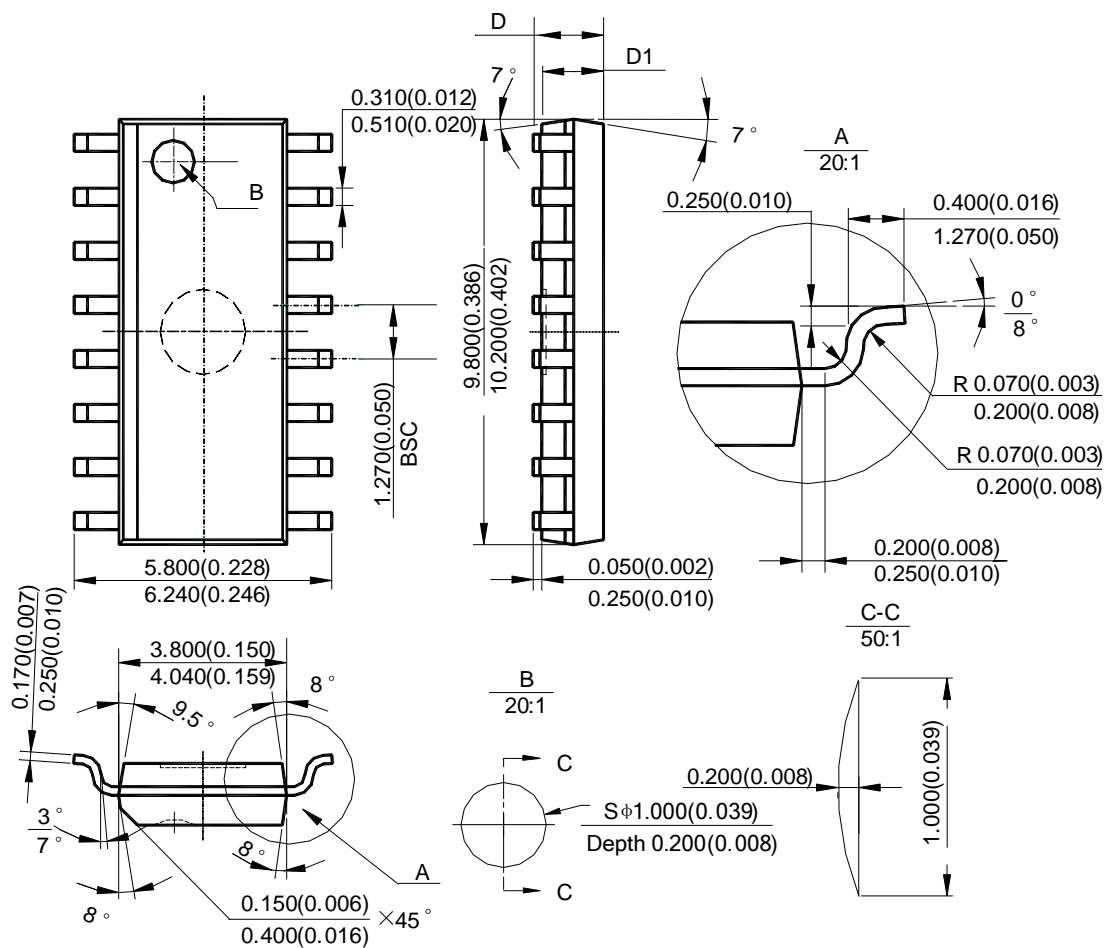
Marking Information

(Top View)



First Line: Logo and Marking ID
(See Ordering Information)
Second Line: Date Code
Y: Year
WW: Work Week of Molding
A: Assembly House Code
XX: 7th and 8th Digits of Batch No.

Package Outline Dimensions (All dimensions in mm(inch).)

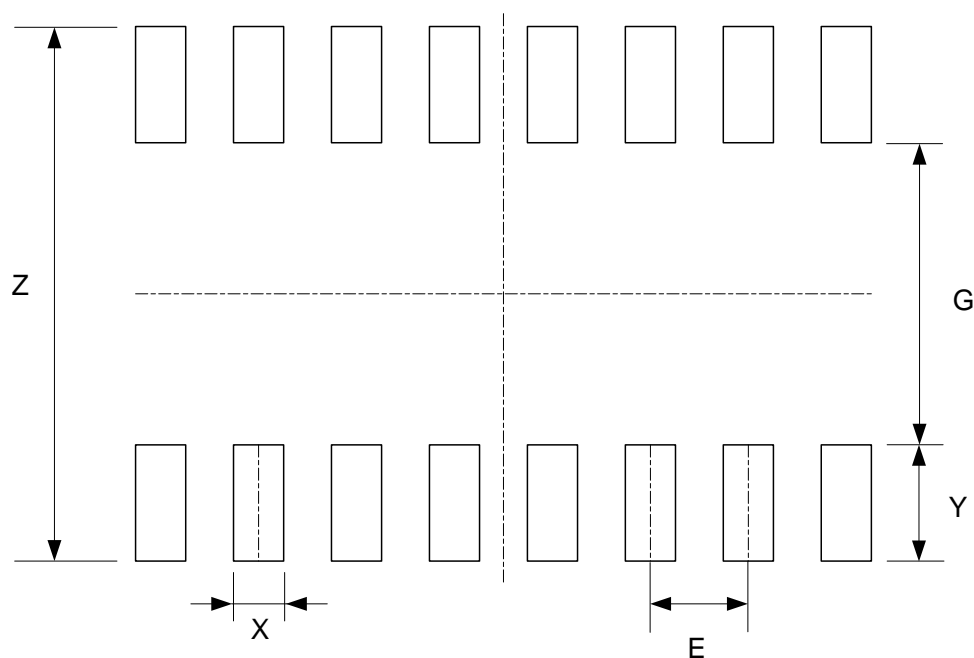
(1) Package Type: SO-16


Note: Eject hole, oriented hole and mold mark is optional.

Symbol	D				D1			
	min(mm)	max(mm)	min(inch)	max(inch)	min(mm)	max(mm)	min(inch)	max(inch)
Option1	1.350	1.750	0.053	0.069	1.250	1.650	0.049	0.065
Option2	-	1.260	-	0.050	1.020	-	0.040	-

Suggested Pad Layout

(1) Package Type: SO-16



Dimensions	Z (mm)/(inch)	G (mm)/(inch)	X (mm)/(inch)	Y (mm)/(inch)	E (mm)/(inch)
Value	6.900/0.272	3.900/0.154	0.650/0.026	1.500/0.059	1.270/0.050

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